

MC33304

Low Voltage Rail-To-Rail Sleep Mode Operational Amplifier

The MC33304 is a monolithic bipolar operational amplifier. This low voltage rail-to-rail amplifier has both a rail-to-rail input and output stage, with high output current capability. In sleep mode, the micropower amplifier is active and waiting for an input signal. When a signal is applied, causing the amplifier to source or sink $\geq 200 \mu\text{A}$ (typically) to the load, it will automatically switch to the awake mode (supplying up to 70 mA to the load). When the output current drops below $90 \mu\text{A}$, the amplifier automatically returns to the sleep mode.

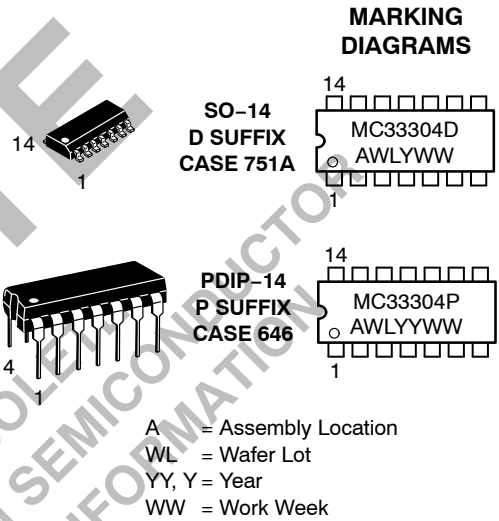
Excellent performance can be achieved as an audio amplifier. This is due to the amplifier's low noise and low distortion. A delay circuit is incorporated to prevent crossover distortion.

- Ideal for Battery Applications
- Full Output Signal (No Distortion) for Battery Applications Down to $\pm 0.9 \text{ VDC}$.
- Single Supply Operation (+1.8 to +12 V)
- Rail-To-Rail Performance on Both the Input and Output
- Output Voltages Swings Typically within 100 mV of Both Rails ($R_L = 1.0 \text{ m}\Omega$)
- Two States: "Sleep Mode" (Micropower, $I_D = 110 \mu\text{A}/\text{Amp}$) and "Awake Mode" (High Performance, $I_D = 1200 \mu\text{A}/\text{Amp}$)
- Automatic Return to Sleep Mode when Output Current Drops Below Threshold, Allowing a Fully Functional Micropower Amplifier
- Independent Sleep Mode Function for Each Amplifier
- No Phase Reversal on the Output for Overdriven Input Signals
- High Output Current (70 mA typically)
- 600Ω Drive Capability
- Standard Pinouts; No Additional Pins or Components Required
- Drop-In Replacement for Many Other Quad Operational Amplifiers
- Similar to MC33201, MC33202 and MC33204 Family
- The MC33304 Amplifier is Offered in the Plastic DIP or SOIC Package (P and D Suffixes)

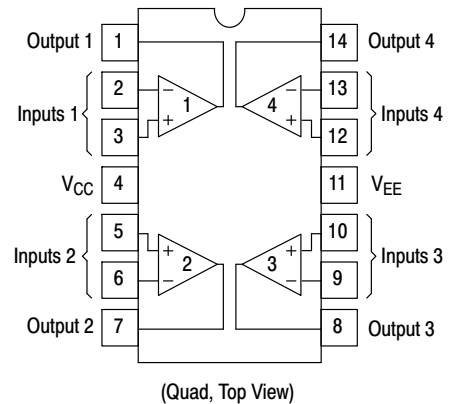


ON Semiconductor

<http://onsemi.com>



PIN CONNECTIONS



ORDERING INFORMATION

Device	Package	Shipping
MC33304D	SO-14	55 Units/Rail
MC33304DR2	SO-14	2500 Tape & Reel
MC33304P	PDIP-14	25 Units/Rail

MC33304

TYPICAL DC ELECTRICAL CHARACTERISTICS (T_A = 25°C)

Characteristic	V _{CC} = 2.0 V	V _{CC} = 3.3 V	V _{CC} = 5.0 V	Unit
Input Offset Voltage V _{IO(max)} MC33304	±10	±10	±10	mV
Output Voltage Swing V _{OH} (R _L = 600 Ω) V _{OL} (R _L = 600 Ω)	1.85 0.15	3.10 0.15	4.75 0.15	V _{min} V _{max}
Power Supply Current per Amplifier (I _D) Awake mode Sleep mode	1.625 140	1.625 140	1.625 140	mA μA

Specifications are for reference only and not necessarily guaranteed. V_{EE} = GND.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage (V _{CC} to V _{EE})	V _S	+16	V
ESD Protection Voltage at Any Pin Human Body Model	V _{ESD}	2000	V
Voltage at Any Device Pin (Note 2)	V _{DP}	V _S ± 0.5	V
Input Differential Voltage Range	V _{IDR}	(Notes 1 and 2)	V
Output Short Circuit Duration	t _s	Indefinite (Note 3)	sec
Maximum Junction Temperature	T _J	+150	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C
Maximum Power Dissipation	P _D	(Note 5)	mW

RECOMMENDED OPERATING CONDITIONS

Characteristic	Symbol	Min	Typ	Max	Unit
Supply Voltage Single Supply Split Supplies	V _S	1.8 ±0.9	- -	12 ±6.0	V
Input Voltage Range, Sleep mode and Awake mode	V _{ICR}	V _{EE}	-	V _{CC}	V
Ambient Operating Temperature Range	T _A	-40	-	+105	°C

- The differential input voltage of each amplifier is limited by two internal diodes. The diodes are connected across the inputs in parallel and opposite to each other. For more differential input voltage range, use current limiting resistors in series with the input pins.
- The common-mode input voltage range of each amplifier is limited by diodes connected from the inputs to both power supply rails. Therefore, the voltage on either input must not exceed supply rail by more than ±500 mV.
- Simultaneous short circuits of two or more amplifiers to the positive or negative rail can exceed the power dissipation ratings and cause eventual failure of the device.
- Rail-to-rail performance is achieved at the input of the amplifier by using parallel NPN-PNP differential stages. When the inputs are near the negative rail (V_{EE} < V_{CM} < 800 mV), the PNP stage is on. When the inputs are above 800 mV (i.e. 800 mV < V_{CM} < V_{CC}), the NPN stage is on. This switching of the input pairs will cause a reversal of input bias current. Slight changes in the input offset voltage will be noted between the NPN and PNP pairs. Cross-coupling techniques have been used to keep this change to a minimum.
- Power dissipation must be considered to ensure maximum junction (T_J) is not exceeded. (See Figure 2)
- When connected as a voltage follower and used in transient conditions, a current limiting resistor may be needed between the output and the inverting input. This is because of the back to back diodes clamped across the inputs. The value of this resistor should be between 1.0 kΩ and 10 kΩ. If the amplifier does not become slew rate limited and is processing low frequency waveforms, then no resistor would be necessary. (The output could be tied directly to the negative input.)

MC33304

DC ELECTRICAL CHARACTERISTICS ($V_{CC} = +5.0\text{ V}$, $V_{EE} = \text{GND}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Input Offset Voltage ($V_{CM} = 0\text{ V}$, $V_O = 0\text{ V}$) (Note 4) Sleep mode and Awake mode $T_A = 25^\circ\text{C}$ $T_A = -40^\circ$ to $+105^\circ\text{C}$	V_{IO}	-10 -13	0.7 -	+10 +13	mV
Average Temperature Coefficient of Input Offset Voltage ($R_S = 50\ \Omega$, $V_{CM} = 0\text{ V}$, $V_O = 0\text{ V}$) $T_A = -40^\circ$ to $+105^\circ\text{C}$, Sleep mode and Awake mode	$\Delta V_{IO}/\Delta T$	-	2.0	-	$\mu\text{V}/^\circ\text{C}$
Input Bias Current ($V_{CM} = 0\text{ V}$, $V_O = 0\text{ V}$) (Note 4) Awake mode $T_A = 25^\circ\text{C}$ $T_A = -40^\circ$ to $+105^\circ\text{C}$	$ I_{IB} $	- -	90 -	+200 +500	nA
Input Offset Current ($V_{CM} = 0\text{ V}$, $V_O = 0\text{ V}$) (Note 4) Awake mode $T_A = 25^\circ\text{C}$ $T_A = -40^\circ$ to $+105^\circ\text{C}$	$ I_{IO} $	- -	3.1 -	+50 +100	nA
Large Signal Voltage Gain ($V_{CC} = +5.0\text{ V}$, $V_{EE} = -5.0\text{ V}$) Awake mode, $R_L = 600\ \Omega$ $T_A = 25^\circ\text{C}$ $T_A = -40^\circ$ to $+105^\circ\text{C}$	A_{VOL}	90 85	116 -	- -	dB
Power Supply Rejection Ratio, Awake mode	PSRR	65	90	-	dB
Output Short Circuit Current (Awake mode) ($V_{ID} = \pm 0.2\text{ V}$) Source Sink	I_{SC}	-200 +50	-89 +89	-50 +200	mA
Output Transition Current, Source/Sink Sleep mode to Awake mode, $V_{CC} = +1.0\text{ V}$, $V_{EE} = -1.0\text{ V}$ Awake mode to Sleep mode, $V_{CC} = +5.0\text{ V}$, $V_{EE} = -5.0\text{ V}$	$ I_{TH1} $ $ I_{TH2} $	- 90	- -	200 -	μA
Output Voltage Swing ($V_{ID} = \pm 0.2\text{ V}$) Sleep mode $V_{CC} = +5.0\text{ V}$, $V_{EE} = 0\text{ V}$, $R_L = 1.0\text{ M}\Omega$ $V_{CC} = 0\text{ V}$, $V_{EE} = -5.0\text{ V}$, $R_L = 1.0\text{ M}\Omega$ $V_{CC} = +2.0\text{ V}$, $V_{EE} = 0\text{ V}$, $R_L = 1.0\text{ M}\Omega$ $V_{CC} = 0\text{ V}$, $V_{EE} = -2.0\text{ V}$, $R_L = 1.0\text{ M}\Omega$ Awake mode $V_{CC} = +5.0\text{ V}$, $V_{EE} = 0\text{ V}$, $R_L = 600\ \Omega$ $V_{CC} = 0\text{ V}$, $V_{EE} = -5.0\text{ V}$, $R_L = 600\ \Omega$ $V_{CC} = +2.0\text{ V}$, $V_{EE} = 0\text{ V}$, $R_L = 600\ \Omega$ $V_{CC} = 0\text{ V}$, $V_{EE} = -2.0\text{ V}$, $R_L = 600\ \Omega$ $V_{CC} = +2.5\text{ V}$, $V_{EE} = -2.5\text{ V}$, $R_L = 600\ \Omega$ $V_{CC} = +2.5\text{ V}$, $V_{EE} = -2.5\text{ V}$, $R_L = 600\ \Omega$	V_{OH} V_{OL} V_{OH} V_{OL} V_{OH} V_{OL} V_{OH} V_{OL} V_{OH} V_{OL} V_{OH} V_{OL}	4.90 - 1.90 - - 4.75 - 1.85 - - - -	4.97 -4.96 1.98 -1.97 4.86 -4.85 1.91 -1.90 2.41 -2.40	- -4.90 - -1.90 - - - -1.85 - -	V
Common Mode Rejection Ratio	CMRR	60	90	-	dB
Power Supply Current (per Amplifier) Sleep mode $V_{CC} = +2.0\text{ V}$, $V_{EE} = 0\text{ V}$ $T_A = +25^\circ\text{C}$ $V_{CC} = +2.5\text{ V}$, $V_{EE} = -2.5\text{ V}$ $T_A = +25^\circ\text{C}$ $T_A = -40^\circ$ to $+105^\circ\text{C}$ $V_{CC} = +12\text{ V}$, $V_{EE} = 0\text{ V}$ $T_A = +25^\circ\text{C}$ Awake mode $V_{CC} = +2.5\text{ V}$, $V_{EE} = -2.5\text{ V}$ $T_A = +25^\circ\text{C}$ $T_A = -40^\circ$ to $+105^\circ\text{C}$	I_D	- - - - -	85 110 - 125 1200 -	- 140 150 - 1625 1750	μA
Thermal Resistance SOIC Plastic DIP	θ_{JA}	- -	145 75	- -	$^\circ\text{C}/\text{W}$

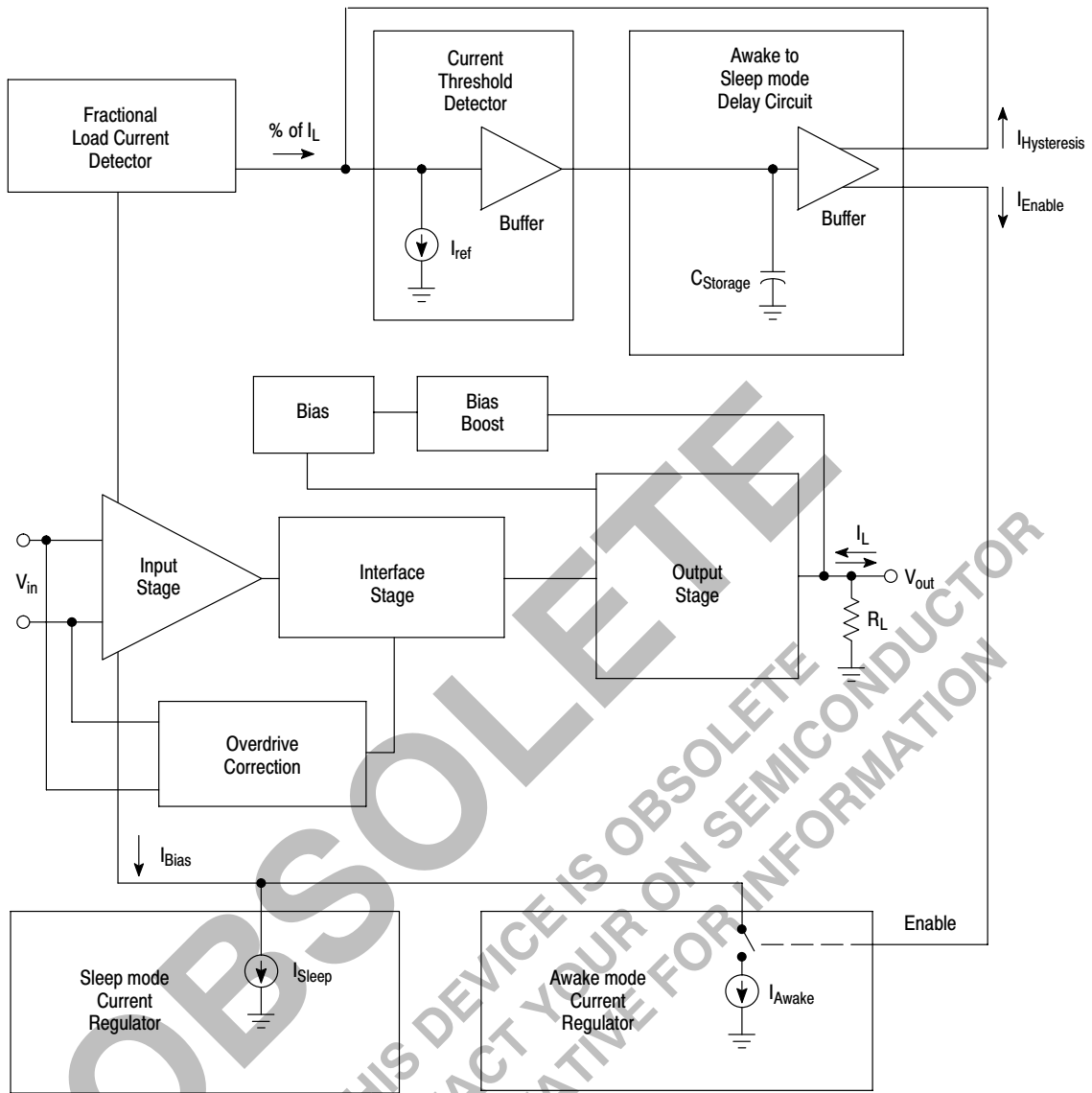
4. Rail-to-rail performance is achieved at the input of the amplifier by using parallel NPN-PNP differential stages. When the inputs are near the negative rail ($V_{EE} < V_{CM} < 800\text{ mV}$), the PNP stage is on. When the inputs are above 800 mV (i.e. $800\text{ mV} < V_{CM} < V_{CC}$), the NPN stage is on. This switching of the input pairs will cause a reversal of input bias current. Slight changes in the input offset voltage will be noted between the NPN and PNP pairs. Cross-coupling techniques have been used to keep this change to a minimum.

MC33304

AC ELECTRICAL CHARACTERISTICS ($V_{CC} = +6.0\text{ V}$, $V_{EE} = -6.0\text{ V}$, $R_L = 600\ \Omega$, $T_A = 25^\circ\text{C}$, unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Slew Rate ($V_{CC} = +2.5\text{ V}$, $V_{EE} = -2.5\text{ V}$, $A_V = +1.0$) (Note 6) Awake mode	SR	0.5	0.89	-	V/ μs
Gain Bandwidth Product ($f = 100\text{ kHz}$) Awake mode	GBW	-	2.2	-	MHz
Gain Margin ($C_L = 0\text{ pF}$) Awake mode Sleep mode ($R_L = 1.0\text{ k}\Omega$)	A_m	- -	6.0 9.0	- -	dB
Phase Margin ($R_L = 1.0\text{ k}\Omega$, $V_O = 0\text{ V}$, $C_L = 0\text{ pF}$) Awake mode Sleep mode	ϕ_m	- -	40 60	- -	Deg
Sleep mode to Awake mode Transition Time $R_L = 600\ \Omega$ $R_L = 10\text{ k}$	t_{tr1}	- -	4.0 12	- -	μsec
Awake mode to Sleep mode Transition Time	t_{tr2}	-	1.5	-	sec
Channel Separation ($f = 1.0\text{ kHz}$) Awake mode	CS	-	100	-	dB
Power Bandwidth ($V_O = 4.0\text{ V}_{pp}$, $R_L = 2.0\text{ k}\Omega$, $\text{THD} \leq 1.0\%$) Awake mode	BW_p	-	28	-	kHz
Distortion ($V_O = 2.0\text{ V}_{pp}$, $A_V = +1.0$) Awake mode ($f = 10\text{ kHz}$) Sleep mode ($f = 1.0\text{ kHz}$, $R_L = \text{Infinite}$)	THD	- -	0.009 0.007	- -	%
Open Loop Output Impedance ($V_O = 0\text{ V}$, $f = 2.0\text{ MHz}$, $A_V = +10$, $I_Q = 10\ \mu\text{A}$) Awake mode Sleep mode	$ Z_{ol} $	- -	100 1000	- -	Ω
Differential Input Impedance ($V_{CM} = 0\text{ V}$) Awake mode Sleep mode	R_{IN}	- -	200 1300	- -	$\text{k}\Omega$
Differential Input Capacitance ($V_{CM} = 0\text{ V}$) Awake mode Sleep mode	C_{IN}	- -	8.0 0.4	- -	pF
Equivalent Input Noise Voltage ($R_S = 100\ \Omega$, $f = 1.0\text{ kHz}$) Awake mode Sleep mode	e_n	- -	15 60	- -	$\text{nV}/\sqrt{\text{Hz}}$
Equivalent Input Noise Current ($f = 1.0\text{ kHz}$) Awake mode Sleep mode	i_n	- -	0.22 0.20	- -	$\text{pA}/\sqrt{\text{Hz}}$

6. When connected as a voltage follower and used in transient conditions, a current limiting resistor may be needed between the output and the inverting input. This is because of the back to back diodes clamped across the inputs. The value of this resistor should be between $1.0\text{ k}\Omega$ and $10\text{ k}\Omega$. If the amplifier does not become slew rate limited and is processing low frequency waveforms, then no resistor would be necessary. (The output could be tied directly to the negative input.)



There are 515 active components for the entire quad device.

Figure 1. Equivalent Circuit Block Diagram (Each Amplifier)

DEVICE DESCRIPTION

The MC33304 will begin to function at power supply voltages as low as $V_S = \pm 0.8$ V. The device has the ability to swing rail-to-rail on both the input and the output. Since the common mode input voltage range extends from V_{CC} to V_{EE} , it can be operated with either single or split voltage supplies. The MC33304 is guaranteed not to latch up or phase reverse over the entire common mode range. However, the output could go into phase reversal state if input voltage is set higher than $+V_{CC}$ or $-V_{EE}$.

When power is initially applied, the part may start to operate in the awake mode. This occurs because of bias currents being generated from the charging of the internal capacitors. When this occurs, the user will have to wait approximately 1.5 seconds before the device will switch back to the sleep mode.

The amplifier is designed to switch from sleep mode to awake mode whenever the output current exceeds a preset current threshold (I_{TH}) of approximately 200 μ A. As a result, the output switching threshold voltage (V_{ST}) is controlled by the output loading resistance (R_L). Large valued load resistors require a large output voltage to switch, but reduce unwanted transitions to the awake mode.

Most of the transition time is consumed slewing in the sleep mode until V_{ST} is reached, therefore, small values of R_L allow rapid transition to the awake mode. The output switching threshold voltage (V_{ST}) is higher for the larger values of R_L , requiring the amplifier to slew longer in the slower sleep mode state before switching to the awake mode.

Although typically 200 μ A, I_{TH} varies with supply voltage, temperature and the load resistance. Generally, any current loading on the output which causes a current greater

than I_{TH} to flow will switch the amplifier into the awake mode. This includes transition currents like those generated by charging load capacitances. In fact, the maximum capacitance that can be driven while attempting to remain in the sleep mode is approximately 300 pF.

The awake mode to sleep mode transition time is controlled by an internal delay circuit, which is necessary to prevent the amplifier from going to sleep during every zero crossing of the output waveform. This delay circuit also eliminates the crossover distortion commonly found in micropower amplifiers.

The MC33304 rail-to-rail sleep mode operational amplifier is unique in its ability to swing rail-to-rail on both the input and output using a bipolar design. This offers a low noise and wide common mode input voltage range. Since the common mode input voltage range extends from V_{CC} to V_{EE} , it can be operated with either single or split voltage supplies.

Rail-to-rail performance is achieved at the input of the amplifiers by using parallel NPN-PNP differential input stages. When the inputs are within 800 mV of the negative rail, the PNP stage is on. When the inputs are more than 800 mV above V_{EE} , the NPN stage is on. This switching of input pairs will cause a reversal of input bias currents. Also, slight differences in offset voltage may be noted between the NPN and PNP pairs. Cross-coupling techniques have been used to keep this change to a minimum.

In addition to the rail-to-rail performance, the output stage is current boosted to provide enough output current to drive 600 Ω loads. Because of this high current capability, care should be taken not to exceed the 150°C maximum junction temperature specification.

MC33304

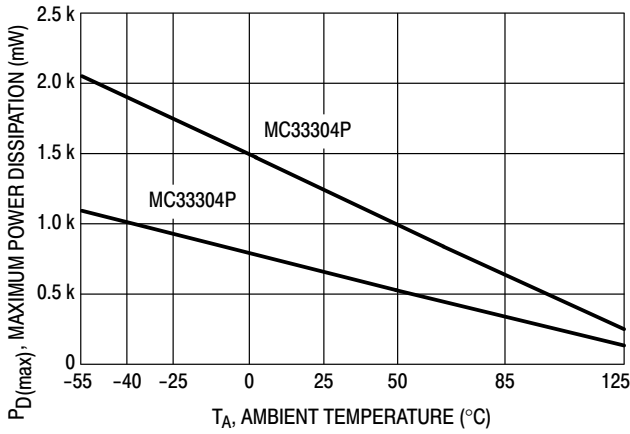


Figure 2. Maximum Power Dissipation versus Temperature

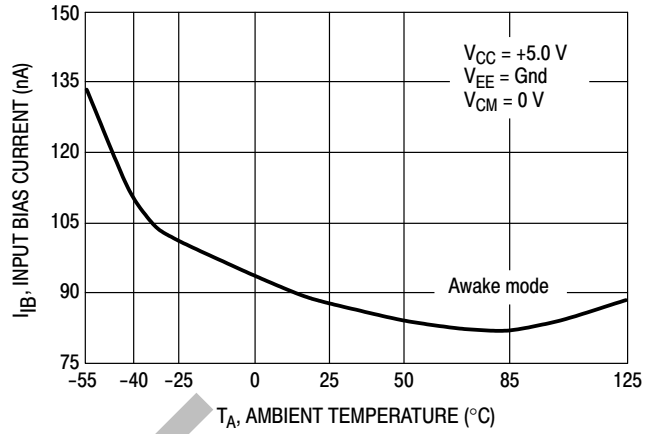


Figure 3. Input Bias Current versus Temperature

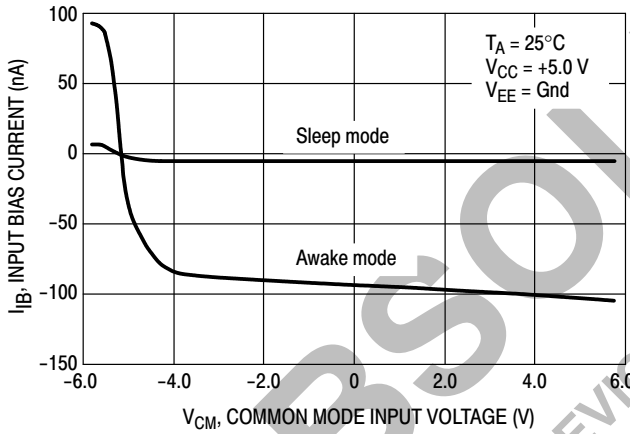


Figure 4. Input Bias Current versus Common Mode Input Voltage

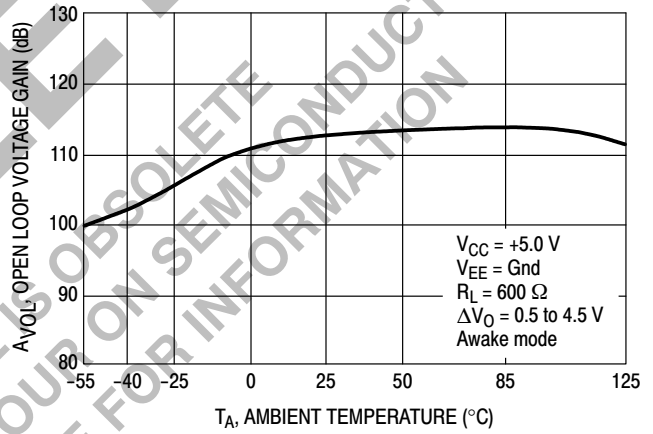


Figure 5. Open Loop Voltage Gain versus Temperature

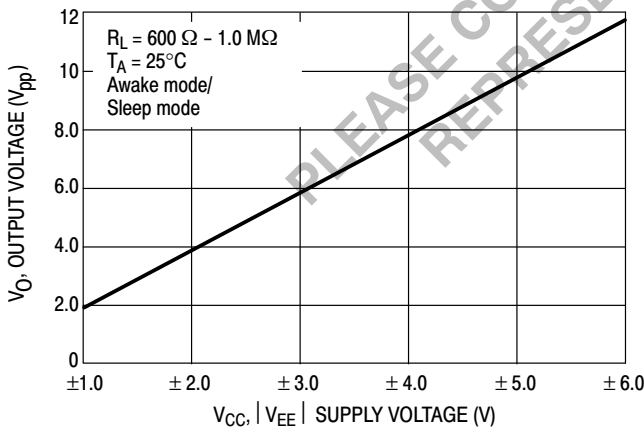


Figure 6. Output Voltage Swing versus Supply Voltage

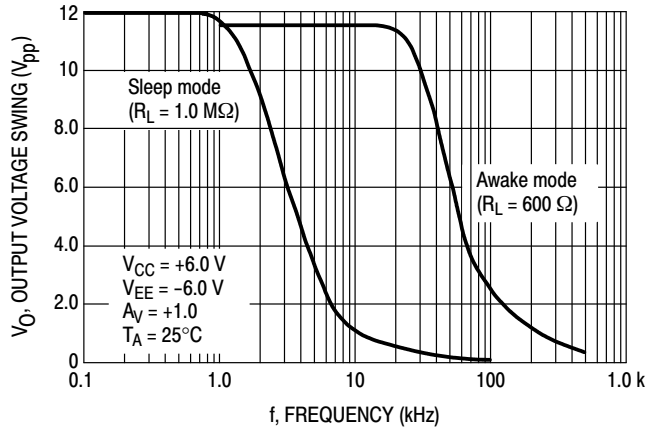


Figure 7. Output Voltage versus Frequency

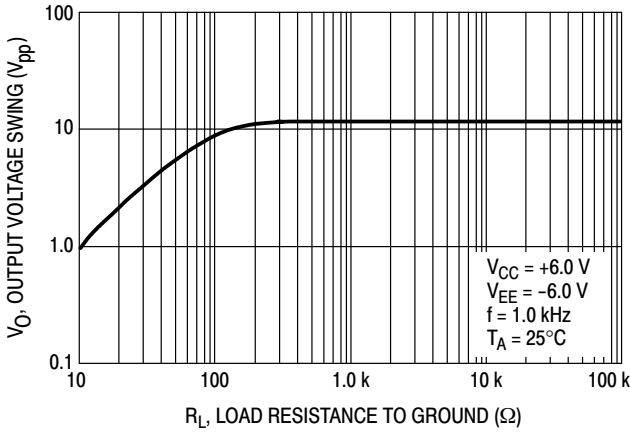


Figure 8. Maximum Peak-to-Peak Output Voltage Swing versus Load Resistance

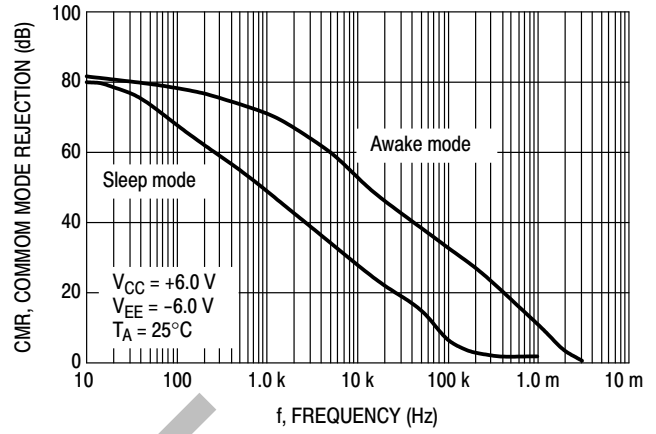


Figure 9. Common Mode Rejection versus Frequency

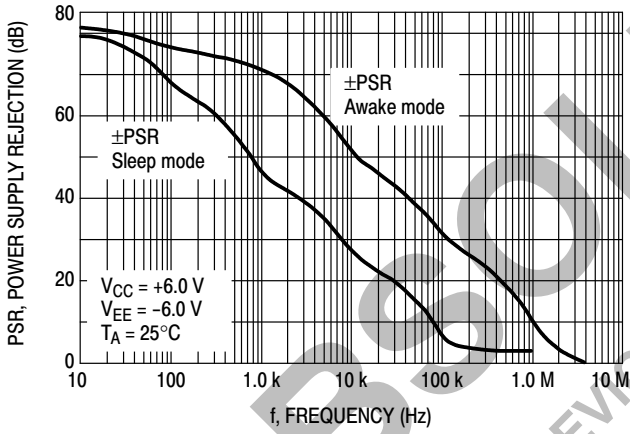


Figure 10. Power Supply Rejection versus Frequency

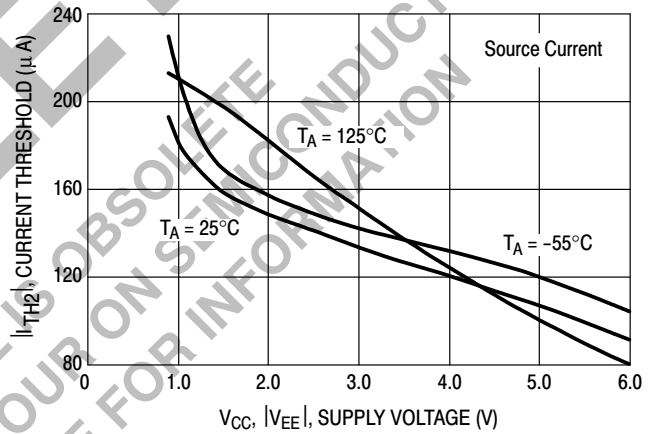


Figure 11. Awake mode to Sleep mode Current Threshold versus Supply Voltage

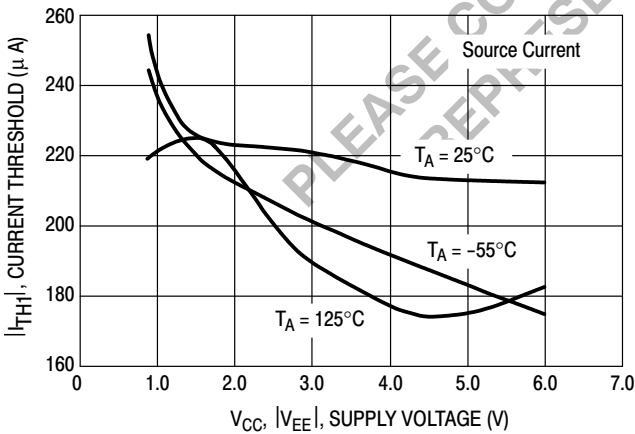


Figure 12. Sleep mode to Awake mode Current Threshold versus Supply Voltage

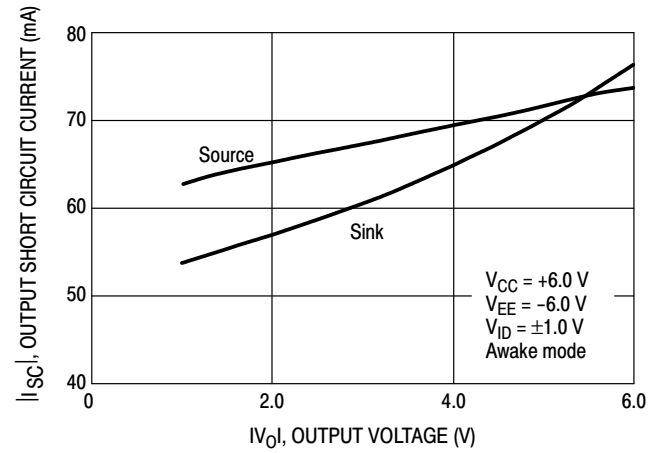


Figure 13. Output Short Circuit Current versus Output Voltage

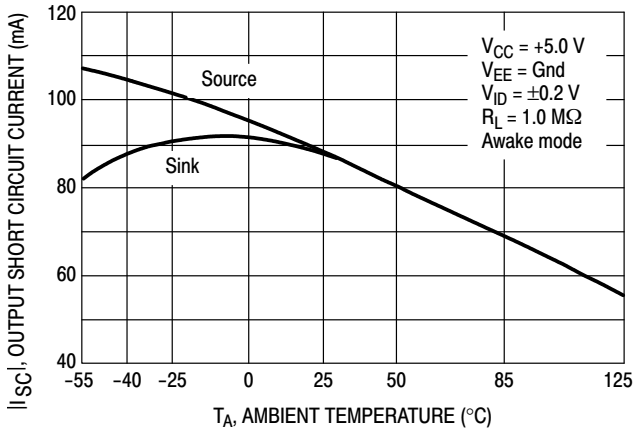


Figure 14. Output Short Circuit Current versus Temperature

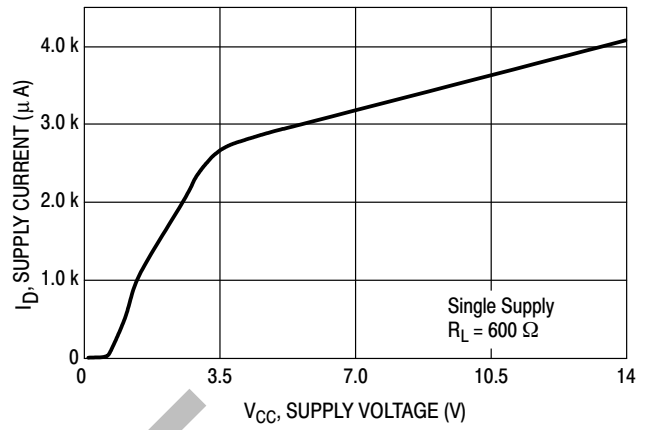


Figure 15. Supply Current versus Supply Voltage with Load

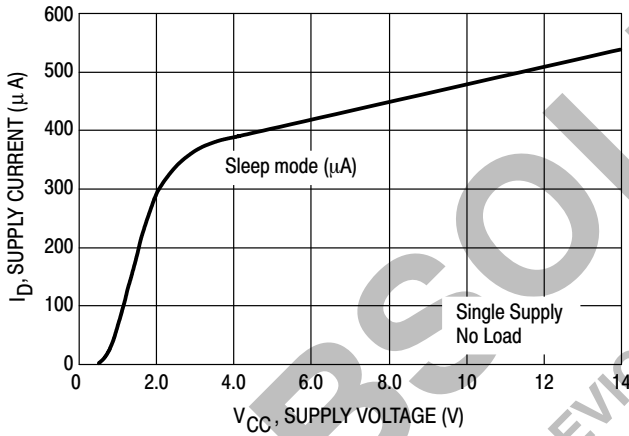


Figure 16. Supply Current versus Supply Voltage

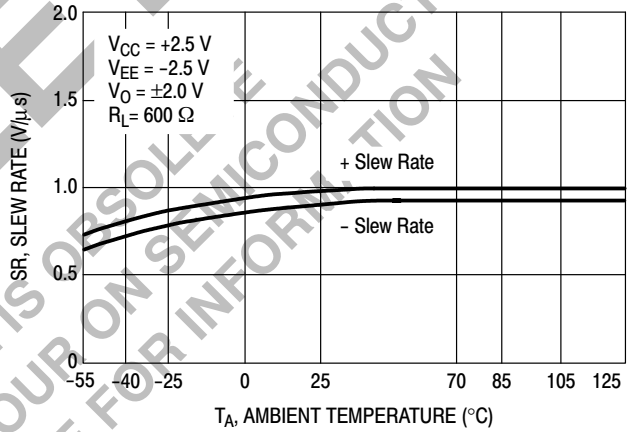


Figure 17. Slew Rate versus Temperature

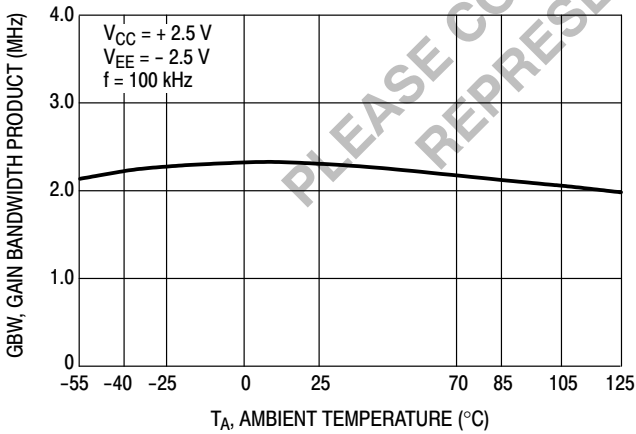


Figure 18. Gain Bandwidth Product versus Temperature

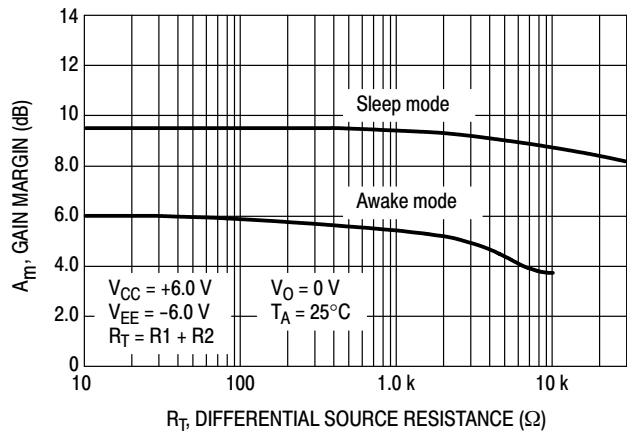


Figure 19. Gain Margin versus Differential Source Resistance

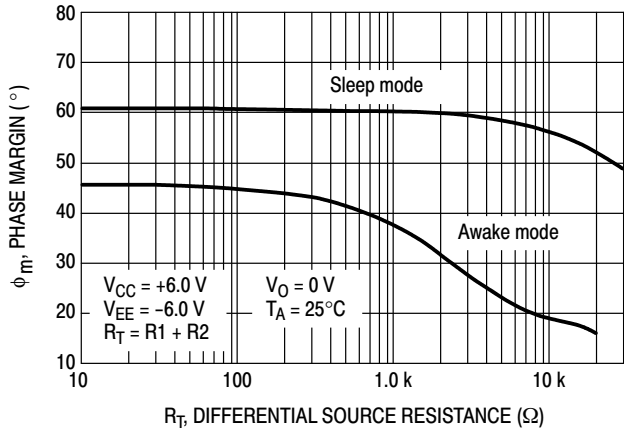


Figure 20. Phase Margin versus Differential Source Resistance

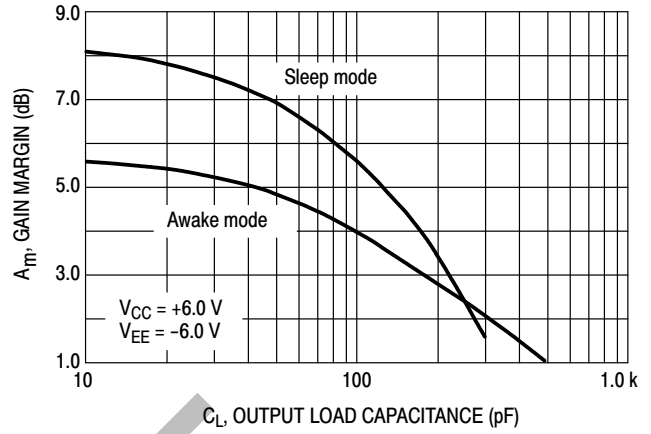


Figure 21. Gain Margin versus Output Load Capacitance

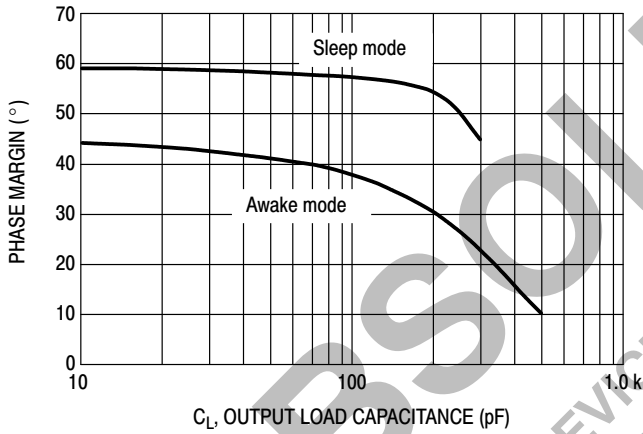


Figure 22. Phase Margin versus Output Load Capacitance

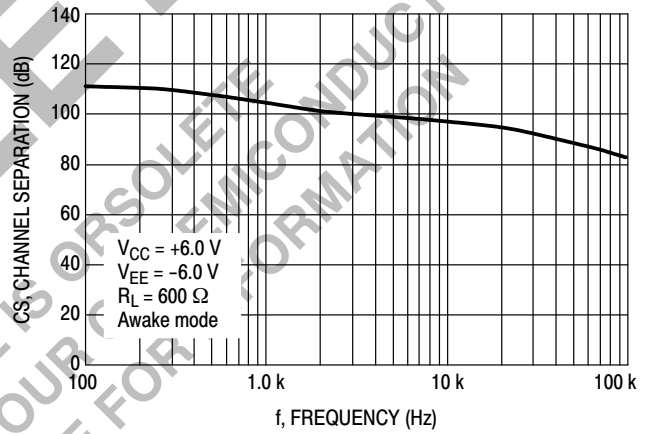


Figure 23. Channel Separation versus Frequency

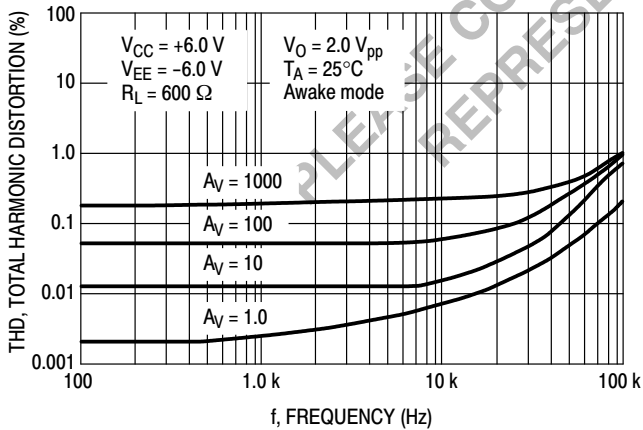


Figure 24. Total Harmonic Distortion versus Frequency

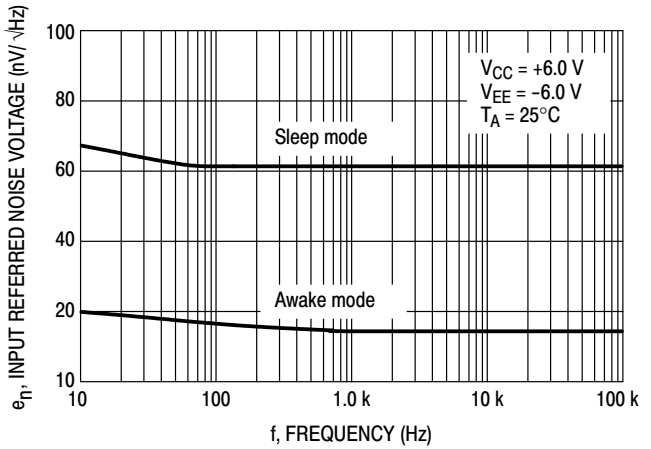


Figure 25. Input Referred Noise Voltage versus Frequency

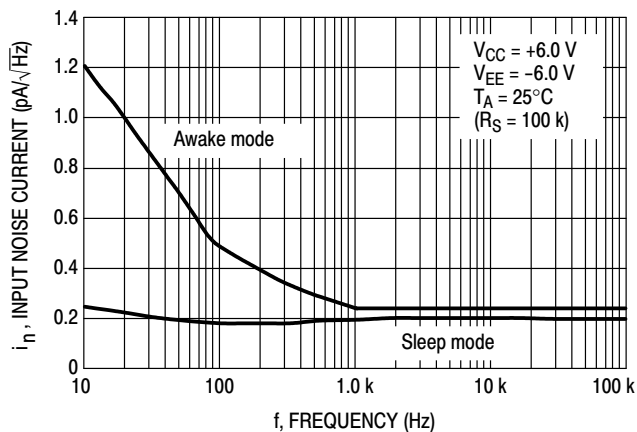


Figure 26. Current Noise versus Frequency

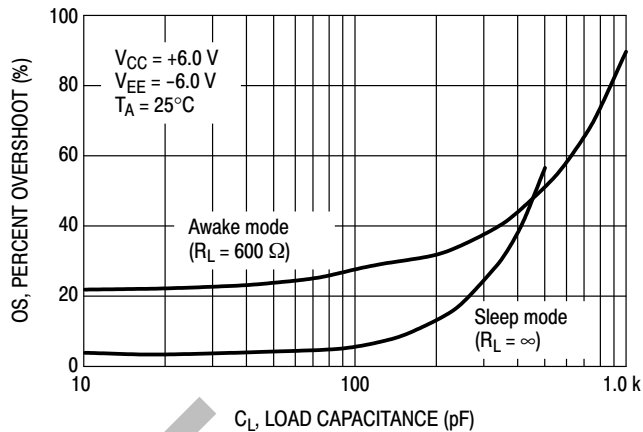


Figure 27. Percent Overshoot versus Load Capacitance

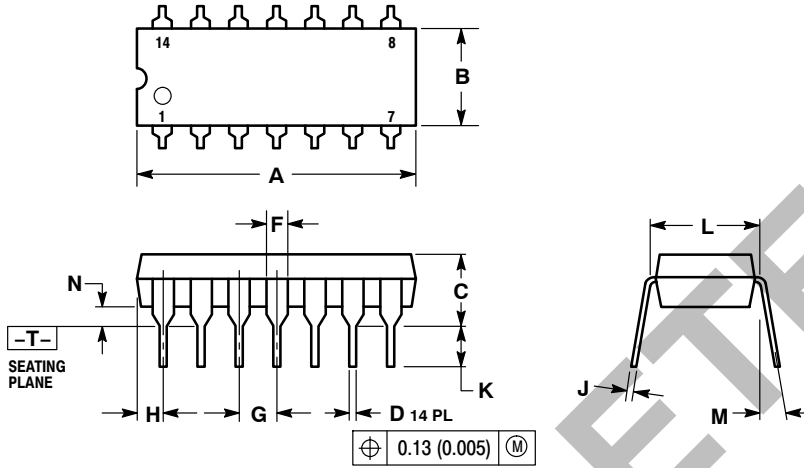
OBSOLETE

THIS DEVICE IS OBSOLETE
PLEASE CONTACT YOUR ON SEMICONDUCTOR
REPRESENTATIVE FOR INFORMATION

MC33304

PACKAGE DIMENSIONS

PDIP-14
P SUFFIX
CASE 646-06
ISSUE M

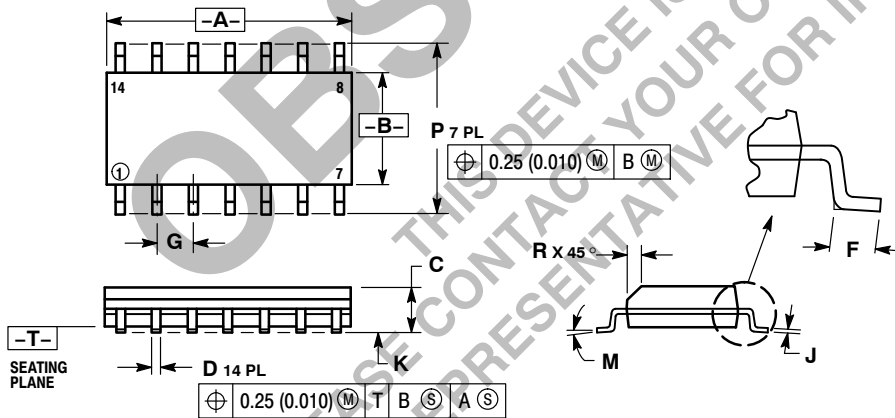


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.715	0.770	18.16	18.80
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC		2.54 BSC	
H	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.290	0.310	7.37	7.87
M	---	10°	---	10°
N	0.015	0.039	0.38	1.01

SO-14
D SUFFIX
CASE 751A-03
ISSUE F



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com
Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local Sales Representative